



PIC16C622A → PIC16F628 Migration

DEVICE MIGRATIONS

This document is intended to describe the functional differences and the electrical specification differences that are present when migrating from one device to the next. Table 1 shows the considerations that must be taken into account when migrating from the PIC16C622A to the PIC16F628. Table 2 shows electrical and timing differences.

Note: Even though compatible devices are tested to the same electrical specifications, the device characteristics may be different from each other (due to process differences). These process differences should have no effect on systems that were designed well within the device specifications. For systems that operate close to the device specifications, process differences may cause the device to behave differently.

Note: Even though the user has made no changes to the oscillator circuit, oscillator operation should be verified to ensure that it starts and performs as expected. Adjusting the loading capacitor values and /or the oscillator mode may be required.

TABLE 1: PIC16C622A → PIC16F628 FUNCTIONAL DIFFERENCES

No.	Module	Differences from PIC16C622A	H/W	S/W	Prog.
1	Oscillator	ER osc mode	Yes	—	—
2	Oscillator	Dual Speed mode	Yes	—	—
3	Oscillator	EC osc mode	Yes	—	—
4	Oscillator	IntRC osc mode	Yes	—	—
5	USART	9-bit USART	Yes	—	—
6	Programming	Low Voltage Programming mode	—	—	Yes
7	Memory	RAM	—	—	Yes
8	Memory	EEPROM Data Memory	—	—	Yes

Legend: H/W - Issues may exist with regard to the application circuit.
 S/W - Issues may exist with regard to the user program.
 Prog. - Issues may exist with regard to programming.

OSCILLATOR MODULE

ER Mode

The PIC16F628 supports the new External Resistor oscillator mode. This mode differs from the traditional RC oscillator mode in that only a resistor to bias current is required. Designers should verify their oscillator design for suitability in the application before use. ER oscillator mode also supports Dual Speed mode.

EC Mode

The PIC16F628 supports the new External Clock-in mode. It is designed for usage in applications where a system clock is available. This mode provides a 1x clock directly to the PIC16F628 core. There is no gain stage in-line. Designers should verify their oscillator design for suitability in the application before use.

IntRC Mode

The PIC16F628 IntRC oscillator mode now supports Dual Speed mode also.

Dual Speed Mode

The PIC16F628 supports Dual Speed mode when configured in either ER or IntRC modes. This sub-mode of operation toggles between a fixed 37 kHz frequency and the frequency set by either ER or IntRC modes.

CONFIG Reg. bits Fosc<2:0>	Description	PCON Reg. bit OSCF	Result
111	ER mode w/clkout	1	ER bias'ed speed
111	ER mode w/clkout	0	37 kHz
110	ER mode w/o clkout	1	ER bias'ed speed
110	ER mode w/o clkout	0	37 kHz
101	IntRC w/clkout	1	4 MHz
101	IntRC w/clkout	0	37 kHz
100	IntRC w/o clkout	1	4 MHz
100	IntRC w/o clkout	0	37 kHz

USART MODULE

9-bit USART

The PIC16F628 USART now supports 9-bit mode. This mode is useful in multi-processor communications. When bits RX9 and ADEN in register RCSTA are set, multi-processor communication is enabled. The 9th bit is used to indicate whether address or data is being transmitted by the Master.

MEMORY ORGANIZATION MODULE

RAM

The PIC16F628 has 224 bytes of data RAM while the PIC16C622A has 128.

EEPROM Data

The PIC16F628 has 128 bytes of EEPROM data memory.

PROGRAMMING MODULE

Low Voltage Programming Mode

The PIC16F628 supports Low Voltage Programming mode. When the LVP bit of the configuration word is asserted, placing a '1' on the RB4/PGM pin will instruct the part to enter Low Voltage Programming mode.

Note 1: While in this mode, the RB4 pin can no longer be used as a general purpose I/O pin.

2: V_{DD} must be 5.0V ±10% during erase/program operations while in low voltage programming mode.

TABLE 2: PIC16C622A → PIC16F628 ELECTRICAL SPECIFICATION DIFFERENCES

Parm. No.	Sym.	Characteristic	PIC16C622A Data Sheet			PIC16F628 Data Sheet			Units	Conditions
			Min	Typ†	Max	Min	Typ†	Max		
D010	IDD	Supply Current (Note 1, 3)	—	0.4	1.2	—	—	0.7	mA	FOSC=4MHz, VDD=3.0V, WDT Disabled, XT osc mode (Note 3) FOSC=10MHz, VDD=3.0V, WDT Disabled, HS osc mode (Note 5)
			—	1.0	2.0	—	—	2.0	mA	
D023	ΔI _{WDT}	WDT Current (Note 4)	—	6.0	10	—	6.0	20	μA	VDD=4.0V
	ΔI _{COMP}	Comparator Current for each Comparator (Note 4)	—	—	12	—	—	25	μA	(125°)
	ΔI _{VREF}	VREF Current (Note 4)	—	30	60	—	30	50	μA	VDD=4.0V
			—	80	135	—	—	135	μA	VDD=4.0V

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
- The test conditions for all IDD measurements in active operation mode are:
 OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD,
 MCLR = VDD; WDT enabled/disabled as specified.
- 2: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.
 - 3: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD}/2R_{ext}$ (mA) with Rext in kΩ.
 - 4: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
 - 5: Commercial temperature range only.
 - 6: Includes EE static current. Does not include EE reads or writes.

TABLE 3: PIC16LC622A → PIC16LF628 ELECTRICAL SPECIFICATION DIFFERENCES

Parm. No.	Sym.	Characteristic	PIC16LC622A Data Sheet			PIC16LF628 Data Sheet			Units	Conditions
			Min	Typ†	Max	Min	Typ†	Max		
D010	IDD	Supply Current (Note 1, 3)	—	—	1.1	—	—	0.6	mA	FOSC=4MHz, VDD=2.5V, WDT Disabled, XT osc mode (Note 3)
D023	ΔI _{WDT}	WDT Current (Note 4)	—	—	—	—	6.0	15	μA	VDD=3.0V
			—	6.0	10	—	—	—	μA	VDD=4.0V
			—	—	12	—	—	—	μA	(125°)
	ΔI _{COMP}	Comparator Current for each Comparator (Note 4)	—	—	—	—	30	50	μA	VDD=3.0V
			—	30	60	—	—	—	μA	VDD=4.0V
	ΔI _{VREF}	VREF Current (Note 4)	—	—	—	—	—	135	μA	VDD=3.0V
—			80	135	—	—	—	μA	VDD=4.0V	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

- 2: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.
- 3: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula $I_r = VDD/2R_{ext}$ (mA) with Rext in kΩ.
- 4: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.
- 5: Includes EE static current. Does not include EE reads or writes.

NOTES:



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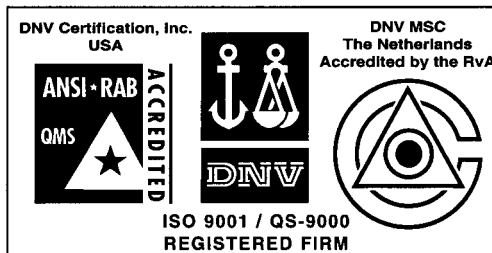
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